

Features

- Hermetic glass -metal seal
- tested according to IEC standards
- High surge capability

330A**Typical Applications**

- DC motor controls
- Controlled DC power supplies
- AC controllers

Major Ratings and Characteristics

Parameters	T330As 2KV	Units
$I_{T(AV)}$	330	A
@ T_c	85	°C
$I_{T(RMS)}$	528	A
I_{TSM} @ 50Hz	5005	A
@ 60Hz	5230	A
$I^2 t$ @ 50Hz	125	KA ² s
@ 60Hz	114	KA ² s
V_{DRM} / V_{RRM}	400 to 1600	V
T_q typical	250	µs
T_J range	- 40 to 125	°C

ELECTRICAL SPECIFICATIONS

Voltage Ratings

Type number	Voltage Code	V_{RRM}/V_{DRM} , maximum repetitive peak reverse voltage V	V_{RSM} , maximum non-repetitive peak rev. voltage V	I_{RRM}/I_{DRM} max. @ $T_J = T_J$ max. mA
T330As	04	400	500	30
	08	800	900	
	12	1200	1300	
	14	1400	1500	
	20	2000	2100	

On-state Conduction

Parameter	T330As	Units	Conditions
$I_{T(AV)}$ Maximum average on-state current @ Case temperature	330	A	180° conduction, half sine wave
	85	°C	
$I_{(RMS)}$ Maximum RMS on-state current	528	A	180° conduction, half sine wave @ $T_C = 80^\circ\text{C}$
I_{TSM} Maximum peak, one-cycle non-repetitive surge current	5000	A	t = 10ms No voltage
	5230		t = 8.3ms reappplied
	4200		t = 10ms 100% V_{RRM}
	4400		t = 8.3ms reappplied
$I^2 t$ Maximum $I^2 t$ for fusing	125	$\text{KA}^2 \text{s}$	t = 10ms No voltage
	114		t = 8.3ms reappplied
	88		t = 10ms 100% V_{RRM}
	81		t = 8.3ms reappplied
$I^2 \sqrt{t}$ Maximum $I^2 \sqrt{t}$ for fusing	1250	$\text{KA}^2 \sqrt{\text{s}}$	t = 0.1 to 10ms, no voltage reappplied
V_{TM} Maximum on-state or forward	1.80	V	pk = 600A, $T_J = 25^\circ\text{C}$, t p = 10ms sine pulse
I_H Maximum holding current	600	mA	$T_J = 25^\circ\text{C}$, anode supply 12V resistive load
I_L Typical latching current	1000(300)		

Switching

Parameter	T330As	Units	Conditions
di/dt ax. non-repetitive rate of rise of turned-on current	1000	A/μs	Gate drive 20V, 20Ω, t _r ≤ 1μs $T_J = T_J$ max, anode voltage ≤ 80% V_{DRM}
t _d ical delay time	1.0	μs	Gate current 1A, dig/dt = 1A/μs $V_d = 0.67\% V_{DRM}$, $T_J = 25^\circ\text{C}$
T _q pical turn-off time	250	μs	$I_{TM} = 300\text{A}$, $T_J = T_J$ max, di/dt = 20A/μs, $V_R = 50\text{V}$ dv/dt = 20V/μs, Gate 0V 100Ω, t _p = 500μs

Blocking

Parameter	T330As	Units	Conditions
dv/dt Maximum critical rate of rise of off-state voltage	500	V/μs	T _J = T _J max linear to 80% rated V _{DRM}
I _{DRM} Max. peak reverse and off-state leakage current	30	mA	T _J = T _J max, rated V _{DRM} /V _{RRM} applied

Triggering

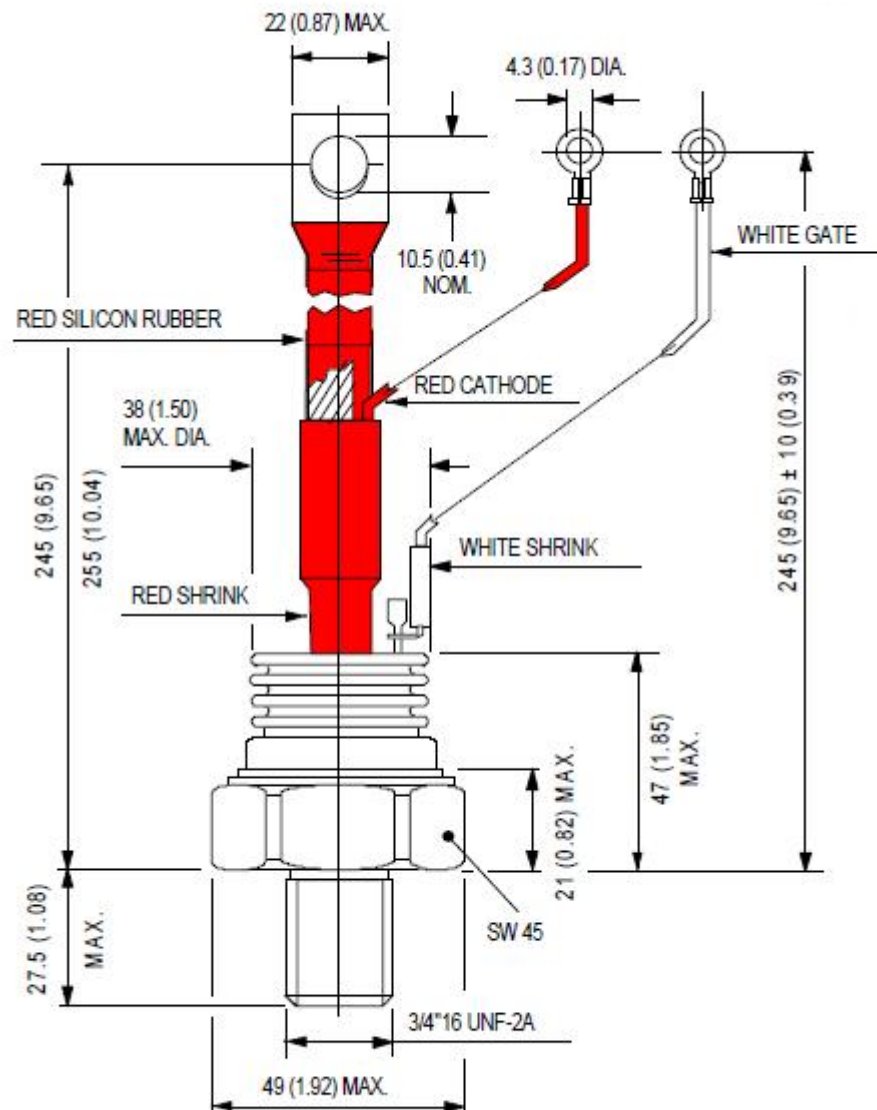
Parameter	T330As		Units	Conditions
P _{GM} Maximum peak gate power	10		W	T _J = T _J max, t _p ≤ 5ms
P _{G(AV)} Maximum average gate power	2.0			T _J = T _J max, f = 50Hz, d% = 50
I _{GM} Max. peak positive gate current	3.0		A	T _J = T _J max, t _p ≤ 5ms
+V _{GM} Maximum peak positive gate voltage	20		V	T _J = T _J max, t _p ≤ 5ms
-V _{GM} Maximum peak negative gate voltage	5.0			
I _{GT} DC gate current required to trigger	TYP.	MAX.	mA	T _J = - 40°C T _J = 25°C T _J = 125°C Max. required gate trigger/ current/ voltage are the lowest value which will trigger all units 12V anode-to-cathode applied
	180	-		
	90	150		
	40	-		
V _{GT} DC gate voltage required to trigger	2.9	-	V	T _J = - 40°C T _J = 25°C T _J = 125°C
	1.8	30		
	1.2	-		
I _{GD} DC gate current not to trigger	10		mA	T _J = T _J max Max. gate current/ voltage not to trigger is the max. value which will not trigger any unit with rated V anode-to-cathode applied
V _{GD} DC gate voltage not to trigger	0.25		V	

Thermal and Mechanical Specification

Parameter	T330As	Units	Conditions
T _J Max. operating temperature range	-40 to 125	°C	
T _{stg} Max. storage temperature range	-40 to 150		
R _{thJC} Max. thermal resistance, junction to case	0.105	K/W	DC operation
R _{thCS} Max. thermal resistance, case to heatsink	0.04		Mounting surface, smooth, flat and greased
T Mounting torque, ± 10%	31(275)	Nm	Non lubricated threads
	24.5(210)	(lbf-in)	Lubricated threads
wt Approximate weight	650	g	

Outline Table

CERAMIC HOUSING



* FOR METRIC DEVICE: M24 X 1.5 - LENGHT SCREW 21 (0.83) MAX.

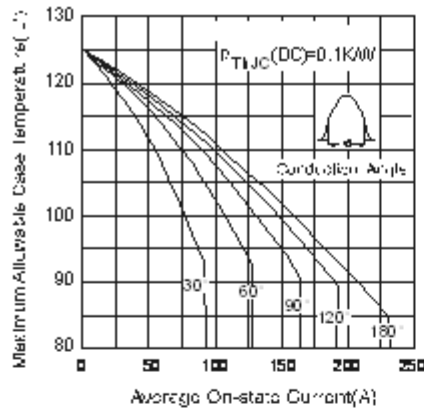


Fig.1-Curve of Ratings Characteristics

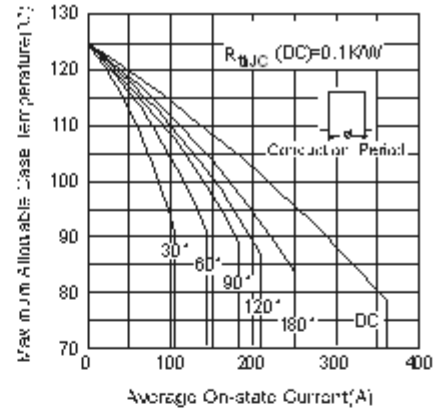


Fig.2-Current Ratings Characteristics

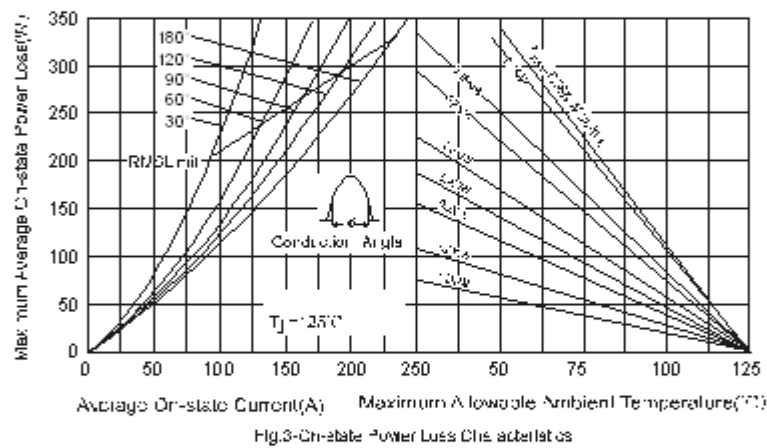


Fig.3-On-state Power Loss Characteristics

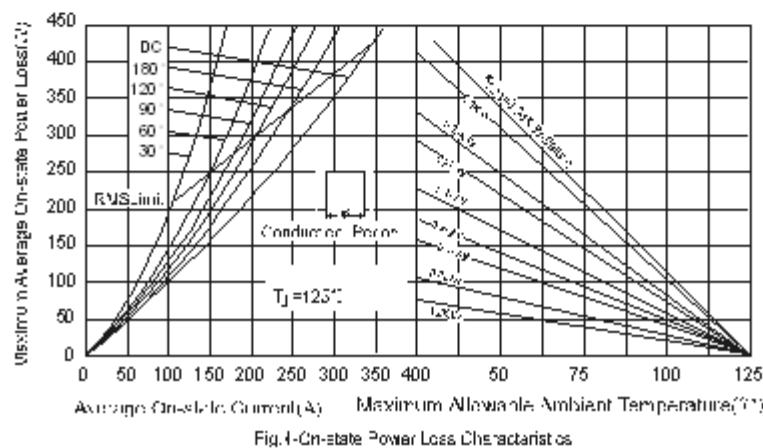


Fig.4-On-state Power Loss Characteristics

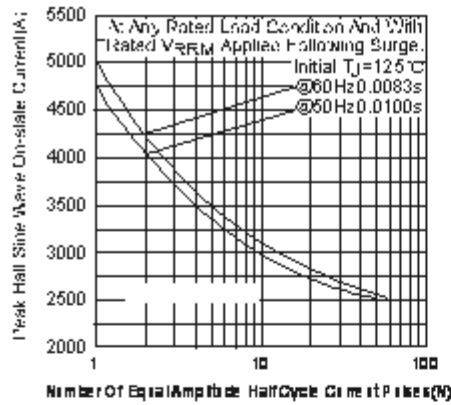


Fig.5-Maximum Non-Repetitive Surge Current

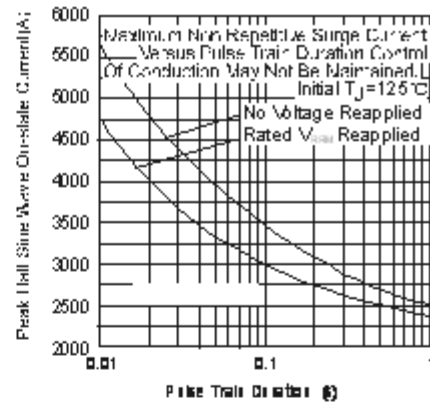


Fig.6-Maximum Non-Repetitive Surge Current

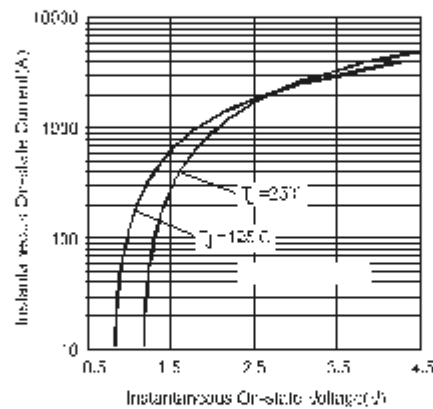


Fig.7-On-state Voltage Drop Characteristics

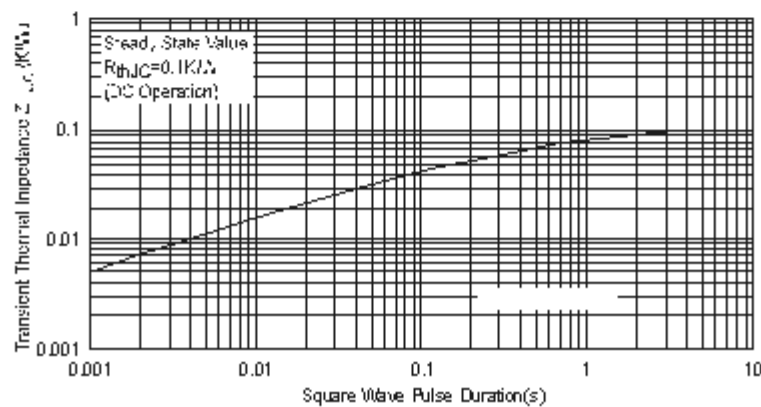


Fig.8-Thermal Impedance Z_{th} Characteristics